

Hardware Documentation

PicoCOMA9X

Version 1.3
(2018-03-13)



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Systeme**

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History

Date	V	Platform	A,M,R	Chapter	Description	Au
2016-12-14	1.0	PicoCOMA9X		*	New document	KW
2017-02-02	1.1	PicoCOMA9X	A	*3.3, 4.5	Add comments for VBUS pin USB CNX	KW
2017-03-24	1.2	PicoCOMA9X	M	4.1	Added two notes for 18Bit mode.	HF
2018-03-13	1.3	PicoCOMA9X	M	3.3	Correct some PU	KW
			R	4.11	Remove mounting option	
			A	4.14, 4.15	Add NAND, RTC	

V Version
A,M,R Added, Modified, Removed
Au Author

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1 Dimension

Board thickness: 1.6 mm \pm 10%
Max. Height of parts on top side: 3.0 mm
Max. Height of parts on bottom side (without connectors): 2.0 mm
Pin pitch of connector: 0.8 mm
Mounting hole diameter 2.8 mm
Mounting holes are isolated from signal ground

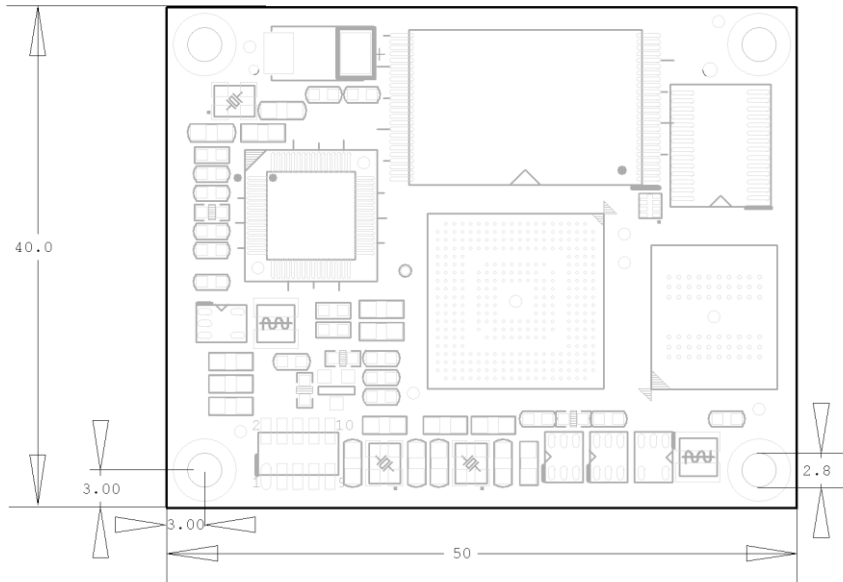


Figure 1: Top view

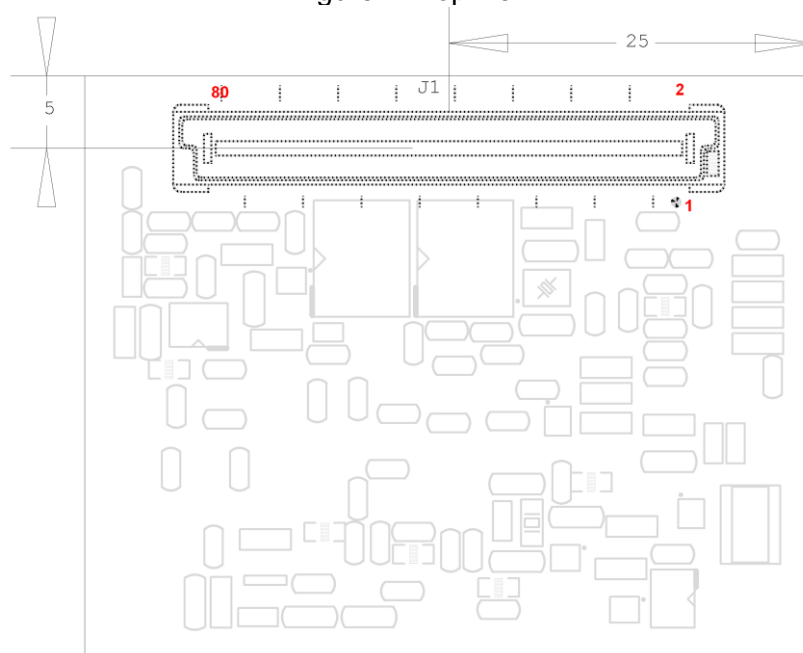


Figure 2: Bottom view

2 Technical Data

2.1 Interface connector

The PicoCOM is equipped with a TycoElectronics 5177984-3 (80 pin, 0.8mm) Connector from '0.8mm Free Height (FH) Connectors' series.

Matching connectors are:

5mm stacking height:	TycoElectronics	5177983-3
9mm stacking height:	TycoElectronics	5-5179009-3
13mm stacking height:	TycoElectronics	5-5179010-3

2.2 Feature list

Power Supply:	+3.3V DC / $\pm 5\%$
Inputs/Outputs:	max. 48 I/O (alternative with interfaces allocated)
Interfaces:	1x Ethernet 10/100Mbit (opt. 2x, mounting option) 2x Serial (optional 3x; for RS232/RS485 with 3.3V-level) 1x USB2.0 Host HS (High Speed 480Mbit/s) 1x USB2.0 Device HS (High Speed 480Mbit/s) 1x I2C (opt. 3x) 1x SPI 1x CAN2.0 (opt. 2x) 1x SD-Card-Slot Interface 1x Audio (Line in/out, analogue) 1x 4 wire touch input, resistive
LCD-interface:	TFT up to 1024x768 pixel, 16/18 bit
RAM:	512 MByte DDR3 SDRAM
Flash:	256 MByte Flash
CPU:	Freescale iMX6SX CPU
Operating Temperature:	0°C ... +70°C (optional -25°C ... +85°C)
Dimensions:	40 x 50 x 10 mm (l x w x h)
Weight:	15 gr.

3 Connectors

3.1 Counting of the connector pins

The connector plug of PicoCOM will be treated as follows.

Pin 1 is marked on chapter 1

Dimension. The row with pin1 contains all odd-numbered pins (1, 3, 5, 7 etc.), and corresponding to this, the row without pin 1 contains all even-numbered pins (2, 4, 6, 8 etc.).

3.2 IO-Pin limitations

PicoCOMA9X is equipped with 48 pins that can be used as digital-IO. Most of these pins are multiplexed, so you have to make sure that these pins are used for one purpose only. For example, if you intend to use IO0 to IO3 you have to make sure that the COM2 is disabled. Additionally there are some IO-Pins which are used internally and whose primary function can't be disabled completely. These pins may carry active signals while the device is booting, which must be kept in mind when connecting external hardware. For example even if you want to use IO14 to IO19 in your application these pins are configured for SD/MMC usage for a short period of time by the boot program to enable booting from SD-Card. Pins that could toggle during boot are tagged in the following table.

3.3 Connector J1

J1				
Pin	Signal	PU/PD on module ⁶⁾	Default Interface	Starter-Kit Interface
1	LAN0_TX-		Ethernet0 TX-	Ethernet0 TX-
2	LAN0_RX-		Ethernet0 RX-	Ethernet0 RX-
3	LAN0_TX+		Ethernet0 TX+	Ethernet0 TX+
4	LAN0_RX+		Ethernet0 RX+	Ethernet0 RX+
5	V33		+3.3V +-5% DC	+3.3V +-5% DC
6	V33		+3.3V +-5% DC	+3.3V +-5% DC
7	GND		Ground	Ground
8	GND		Ground	Ground
9	VBAT		+3..+3.6V DC (RTC backup battery)	+3..+3.6V DC (RTC backup battery)
10	nRES	PU 10k	Reset In (open drain)	Reset In (open drain)
11	IO47 ²⁾		IO47	IO47/ CTS1
12	IO48 ²⁾		IO48/SDHC_CDn	IO48
13	IO0 ²⁾		IO0	TxD2
14	IO1 ²⁾		IO1	RxD2
15	IO2 ²⁾		IO2	RTS2/ TxD3
16	IO3 ²⁾		IO3	CTS2/ RxD3
17	IO4 ¹⁾		COM1 TXD	TxD1 (standard debug port)
18	IO5 ¹⁾		COM1 RXD	RxD1 (standard debug port)
19	HDP A		USB Host 1 +	USB Host 1 +
20	HDMA		USB Host 1 -	USB Host 1 -
21	DDP		USB Device +	USB Device +
22	DDM		USB Device -	USB Device -

J1				
Pin	Signal	PU/PD on module ⁶⁾	Default Interface	Starter-Kit Interface
23	IO6 ⁹⁾		USB CNX (input 5V)	USB CNX (detection, input 5V)
24	IO7		USB PWR (output)	USB PWR (output)
25	GND		Ground	Ground
26	IO8		SPI MISO	SPI MISO
27	IO9 ^{2) 8)}		SPI MOSI	SPI MOSI
28	IO10 ²⁾		SPI SPCK	SPI SPCK
29	IO11 ^{2) 8)}		SPI PCS0	SPI PCS0
30	IO49 ²⁾ CAN0_TX I2C1_SDA ⁷⁾		CAN0_TX	CAN_TX
31	IO50 ²⁾ CAN0_RX I2C1_SCL ⁷⁾		CAN0_RX	CAN_RX
32	IO12 ²⁾ I2C4_SDA CAN1_TX ⁷⁾		I2C1 SDA	I2C1 SDA
33	IO13 ²⁾ I2C4_SCL CAN1_RX ⁷⁾		I2C1 SCL	I2C1 SCL
34	IO14 ²⁾		SD DAT0	SD DAT0
35	IO15 ²⁾		SD DAT1	SD DAT1
36	IO16 ²⁾		SD DAT2	SD DAT2
37	IO17 ²⁾		SD DAT3	SD DAT3
38	IO18 ²⁾		SD CLK	SD CLK
39	IO19 ²⁾		SD CMD	SD CMD
40	IO20 ²⁾		IRQ0	IRQ0
41	IO21 ²⁾ ELED1 ⁵⁾		PWM1 LINKLED Ethernet1	IO21
42	GND		Ground	Ground

43	IO22 ³⁾		LCD0 (R1)	LCD-R0
44	IO23 ³⁾		LCD1 (R2)	LCD-R1
45	IO24 ³⁾		LCD2 (R3)	LCD-R2
46	IO25 ³⁾		LCD3 (R4)	LCD-R3
47	IO26 ³⁾		LCD4 (R5)	LCD-R4
48	IO27 ³⁾		LCD5 (G0)	LCD-G0
49	IO28 ³⁾		LCD6 (G1)	LCD-G1

J1				
Pin	Signal	PU/PD on module ⁶⁾	Default Interface	Starter-Kit Interface
50	IO29 ³⁾		LCD7 (G2)	LCD-G2
51	IO30 ³⁾		LCD8 (G3)	LCD-G3
52	IO31 ³⁾		LCD9 (G4)	LCD-G4
53	IO32 ³⁾		LCD10 (G5)	LCD-G5
54	IO33 ³⁾		LCD11 (B1)	LCD-B0
55	IO34 ³⁾		LCD12 (B2)	LCD-B1
56	IO35 ³⁾		LCD13 (B3)	LCD-B2
57	IO36 ³⁾		LCD14 (B4)	LCD-B3
58	IO37 ³⁾		LCD15 (B5)	LCD-B4
59	IO38 ³⁾		LCDCLK	LCD-SHIFT
60	IO39 ³⁾		LCDDEN	LCD-M
61	GND		Ground	Ground
62	GND		Ground	Ground
63	IO40 ³⁾	PD 100k	LCD16 (HSYNC/B0)	LCD-LINE
64	IO41 ³⁾	PD 100k	LCD17 (VSYNC/R0)	LCD-FRAME
65	IO42 ²⁾		LCDDCC (PWM)	VEEK
66	IO43 ²⁾	PU 10k ⁸⁾	LCDPOWn	LCD Power on (low active)
67	IO44 ²⁾	PU 10k ⁸⁾	BLPOWn	Backlight Power on (low active)
68	IO45 ²⁾		LC DENA	LCD Enable (not used on TFT)
69	IO46 ²⁾		COM1 RTS	RTS1
70	ELED0		LINKLED Ethernet0	Ethernet LED0
71	TSPX		Touch X+	TSPX
72	GND		Ground	Ground
73	GND		Ground	Ground
74	TSMX		Touch X-	TSMX
75	TSPY		Touch Y+	TSPY
76	TSMY		Touch Y-	TSMY

77	LOUT LAN1_TX- ⁵⁾		Line Out Left Ethernet1 TX-	Line Out Left
78	ROUT LAN1_RX- ⁵⁾		Line Out Right Ethernet1 RX-	Line Out Right
79	LIN LAN1_TX+ ⁵⁾		Line In Left Ethernet1 TX+	Line In Left
80	RIN LAN1_RX+ ⁵⁾		Line In Right Ethernet1 RX+	Line In Right

Table 1: J1 - main connector

- 1) These IO-Pins are active signals during boot. Don't drive during boot process.
 - 2) These IO-Pins can be reconfigured as GPIO.
 - 3) If display is not used all these IO-Pins can be reconfigure as GPIO together
 - 5) Mounting option for 2nd LAN instead Audio
 - 6) Mounted on HW. Some additional PU/PD can be switched on by software. Please refer SW manual or ask our support team.
 - 7) Alternate pin configuration function in software. Please refer the software manual or ask our technical support. I2C0 can only used on one pair of pins at the same time (identical hardware block), I2C1 also. There is no compatibility to other picoCOM using this alternative function.
 - 8) From HW version 1.2 on. IO9 and IO11 are exchanged on HW Rev 1.1
please refer chapter 4.6 SPI Interface
 - 9) connect directly to VCC pin of USB device connector without serial resistor!
- All digital signals does have 3.3V logic compliant level.
See starterkit documentation for connection examples.

4 Interface and signal description

4.1 LCD-Connection

All signals are working with 3.3V logic pegel. For all LCD signals we strictly recommend serial resistors or filter nearby the module connector to reduce EMI.

Pin (80 Pin, J1)	Signal	TFT			
		18 bit (without HSYNC/VSYNC) ¹	18 bit (with HSYNC/VSYNC) ²	16 bit	15 bit
43	LCD0	R1	R1	R0(LSB)	R0(LSB)
44	LCD1	R2	R2	R1	R1
45	LCD2	R3	R3	R2	R2
46	LCD3	R4	R4	R3	R3
47	LCD4	R5(MSB)	R5(MSB), R0(LSB)	R4(MSB)	R4(MSB)
48	LCD5	G0(LSB)	G0(LSB)	G0(LSB)	---
49	LCD6	G1	G1	G1	G0(LSB)
50	LCD7	G2	G2	G2	G1
51	LCD8	G3	G3	G3	G2
52	LCD9	G4	G4	G4	G3
53	LCD10	G5(MSB)	G5(MSB)	G5(MSB)	G4(MSB)
54	LCD11	B1	B1	B0(LSB)	B0(LSB)
55	LCD12	B2	B2	B1	B1
56	LCD13	B3	B3	B2	B2
57	LCD14	B4	B4	B3	B3
58	LCD15	B5(MSB)	B5(MSB), B0(LSB)	B4(MSB)	B4(MSB)
59	LCDCLK	DCLK			
63	LCD16	B0(LSB)	HSYNC	HSYNC	HSYNC
64	LCD17	R0(LSB)	VSYNC	VSYNC	VSYNC
60	LCDDEN	DE	DE	DE	DE
68	LCDENA	---	---	---	---
65	LCDDCC	PWM Backlight			
66	LCDPOWn	LCD Power On (active low)			
67	CFLPOWn	Backlight Power On (active low)			

Table 2: LCD Pins – TFT

¹ This mode PicoCOMA9X outputs 18 data bits. Please also configure your display driver in the same way. HSYNC/VSYNC mode is not possible in this configuration. You must enable DE mode.

² This mode PicoCOMA9X outputs 16 data bits. Please also configure your display driver in the same way.

Note: [Most displays support HSYNC/VSYNC or DE mode](#). Please be sure just connect only useful signals at same time. The 18bit w/o HSYNC/VSYNC mode needs a special configuration made by software. Please refer the SW manual for this configuration.

4.2 Ethernet connection

Ethernet TX+/- and LAN RX+/- are 100 \pm 20% Ohm differential pairs to a 1:1/1:1 transformer. We recommend a connector with integrated transformer in short distance (less than 1 inch = 25.4 mm) to the module connector. The RX pair should have a 0.1 inch min. distance to TX pair to avoid crosstalk. The intra pair mismatch of each differential pair should be <10 mil (0.254mm).

The transformer midpoint should be connected to the 3.3V power supply.

LED signal is able to drive a 3.3V powered LED with 5mA directly to GND.

If ethernet is not used please leave signals unconnected.

4.3 Serial port (UART)

The module provides a maximum of three different serial ports with 3.3V TTL signals. These signals are not 5V compliant. Please use a transceiver with 3.3V power supply. If you don't need the serial port this pins can be used optional as GPIOs.

PicoCOMA9X UART Interfaces			
J1 Pin	UART	Standard	Option
11 ²⁾	SCI1_CTS	IO47	IO47, SCI1_CTS
69 ²⁾	SCI1_RTS	IO46	IO46, SCI1_RTS
13 ²⁾	SCI2_TX	SCI2_TX	IO0
14 ²⁾	SCI2_RX	SCI2_RX	IO1
15 ²⁾	SCI3_TX	SCI2_RTS	IO2, SCI3_TX
16 ²⁾	SCI3_RX	SCI2_CTS	IO3, SCI3_RX
17 ²⁾	SCI1_TX	SCI1_TX	IO4
18 ²⁾	SCI1_RX	SCI1_RX	IO5

Table 3: UART Interfaces

¹⁾ These IO-Pins are active signals during boot. Don't drive during boot process.

²⁾ These IO-Pins can be reconfigured as GPIO.

Table 4: UART FIFO depth

4.4 USB Host

The 90 Ohm differential pair of USB signals doesn't need any termination. For external ports EMV protection is required nearby the USB connector.

With the USB_PWR signal you could switch on the USB power on your current limiting IC.

The usb.org webpage provides "[High Speed USB Platform Design Guidelines](#)" with highly recommended informations for a proper working USB design.

ESD and EMV protection is required on baseboard.

If the USB port is not used please leave open.

4.5 USB device

The 90 Ohm differential pair of USB signals doesn't need any termination. For external ports ESD and EMV protection is required nearby the USB connector.

The USB_CNX signal does detect a connected host by detecting the voltage. This signal is 5V tolerant and needs a level above 3.7V. **Do not use a voltage divider or serial resistor.**

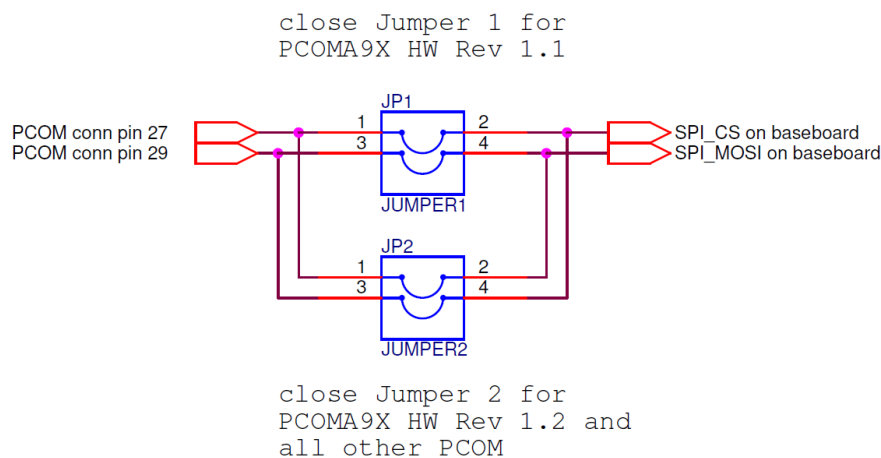
ESD and EMV protection is required on baseboard.

If the USB device port is not used please leave open.

4.6 SPI Interface

The module supports one HS SPI (Serial Peripheral Interface) with one chip select. Signals are 3.3V compliant.

At HW Rev. 1.1 is a failure (will be fixed on Rev 1.2). SPI is not backward compatible to other modules in PicoCOM formfactor. The signals SPI_CS on pin 29 and SPI_MOSI on pin 27 are interchanged. For full support on customers system it needs jumper:



Both pins are configurable as GPIO. In this case this interchange can be handled in SW.

4.7 I2C Interface

The module supports a maximum of three I2C interfaces. One is compatible with PicoCOM standard. Signals are 3.3V compliant and don't have pullups on module. So please add 2.2 kOhm pullups to 3.3V on baseboard. 5V devices on baseboard need a level shifter.

PicoCOMA9X I2C Interfaces				
J1 Pin		I2C	Standard	Optional
30 ²⁾		I2C0_SDA	CAN0_TX	IO49, I2C0_SDA
31 ²⁾		I2C0_SCL	CAN0_RX	IO50, I2C0_SCL
32 ²⁾		I2C1_SDA	I2C1_SDA	IO12, CAN1_TX
33 ²⁾		I2C1_SCL	I2C1_SCL	IO13, CAN1_RX

Table 5: I2C Interfaces

¹⁾ These IO-Pins are active signals during boot. Don't drive during boot process. Baseboard pullups are not allowed during RESET (malfunction!). We strictly recommend schematic review on our support.

²⁾ These IO-Pins can be reconfigured as GPIO.

4.8 CAN Interface

PicoCOMA9X provides up-to two CAN interfaces. One is compatible with the PicoCOM standard. The second shares pins with the I2C interface. The Vybrid SoC is used for the CAN function. PicoCOMA9X provide the CAN bus transmit and receive 3.3V TTL signal without any termination.

Needs a 3.3V transceiver like SN65HVD230 to the CAN bus.

Signals can be optional used as GPIO or I2C.

PicoCOMA9X CAN Interfaces			
J1 Pin	CAN	Standard	Option
30 ²⁾	CAN0_TX	CAN0_TX	IO49, I2C0_SDA
31 ²⁾	CAN0_RX	CAN0_RX	IO50, I2C0_SCL
32 ²⁾	CAN1_TX	I2C1_SDA	IO12, CAN1_TX
33 ²⁾	CAN1_RX	I2C1_SCL	IO13, CAN1_RX

Table 6: CAN Interfaces

¹⁾ These IO-Pins are active signals during boot. Don't drive during boot process.

²⁾ These IO-Pins can be reconfigured as GPIO.

4.9 SDcard

The interface is supporting a SD card channel. For specification and licensing please refer the website of the SD Association <http://www.sdcard.org>. Pullups are integrated on the module. Card detection and write protection are not supported by the PicoCOM standard.

Unused signals should be left unconnected.

Signals can be optional used as GPIO.

PicoCOMA9X SD Card Interface		
J1 Pin	Standard	Option
12	IO48	SDHC_CDn ²⁾ (low active)
34	SD DAT0	IO14 ²⁾
35	SD DAT1	IO15 ²⁾
36	SD DAT2	IO16 ²⁾
37	SD DAT3	IO17 ²⁾
38	SD CLK	IO18 ²⁾
39	SD CMD	IO19 ²⁾

Table 7: SD card Interface

¹⁾ These IO-Pins are active signals during boot. Don't drive during boot process.

²⁾ These IO-Pins can be reconfigured as GPIO.

4.10 Touch Interface

The integrated resistive touch controller will support 4 wire analog resistive touch panels without any additional circuit.

4.11 Audio I/F

The onboard soundcodec does support a stereo analog input and a stereo analog output for 1Vpp audio signals. This signals needs serial capacitors. ESD and EMV protection is required on baseboard.

4.12 IO/ IRQ

Multiple purpose pins with 3.3V logic signal level.

4.13 nRES

Reset input to drive with open drain or open collector 3.3V compliant from baseboard. We recommend to pull low this pin with a VCC voltage supervisor on power up with the power-good signal from power supply or using a voltage supervisor. There is now voltage supervisor on the module.

4.14 NAND Flash

By default, boot mode of efusA7UL is configured for NAND boot. efusA7UL implements the following to get reliable boot over long time:

- Use of SLC NAND flash memory
- Boot loader stored two times in flash memory
- Flash data protected by 32 bit ECC
- Algorithm for block refresh
- Operating system Linux uses UBI as file system
- Operating system Windows can use F3S to be robust against power failures

4.14.1 NAND Flash Data Retention

The NAND Flash is based on “single level cell” (SLC) technology. This technology is ten times more robust compared to “multi level cell” (MLC) technology. It is important to know, that high temperature impacts data retention of SLC or MLC flash. Independent if the device is powered or not. Please contact us, if your device is constantly in an environment where temperature is higher than 50°C.

4.15 RTC

There is a NXP PCF8563TS or compatible implemented on board. The accuracy is limited because the warming of the crystal on the board in operation. The RTC could drift some seconds per day. For better accuracy F&S does support a mounting option with XTCO. Please ask your sales contact for pricing and minimal order quantity, if you have enhanced requirements.

5 Electrical Data

5.1 Power supply

Power supply:	3.3V +/- 5%
maximum power consumption with 1x LAN:	2.85 Watt
maximum power consumption with 2x LAN:	3.1 Watt
<small>(theoretical value, Summary of max. datasheet value all chips on module w/o SD card, LCD, USB, backplane logic & transceiver)</small>	
Capacitor charge current on power on:	2 A
Power supply RTC battery:	2.0 ... 3.6 V
Power consumption @25°C:	typ. 3µA max. 10µA@25°C

Power consumption of connected devices like display, USB devices, SD card has to be added for power calculation.

Real power consumption could be much lower depends CPU workload, used graphic interfaces and features and the workload on I/O interfaces.

5.2 Absolute maximum ratings

Description	Condition	Min	Max	Unit
Input Voltage range 3.3V IO pins		-0.3	OVDD+0.3	V
USB VBUS (goldfinger pin 217)		-0.3	5.25	V

Table 8: maximum ratings

5.3 DC electrical characteristics for 3.3V IO pins

VDD= 3.3V +/- 5%

Parameter	Description	Condition	Min	Max	Unit
Vih	High Level Input Voltage		0.7*VDD	VDD	V
Vil	Low Level Input Voltage		0	0.3*VDD	V
Voh	High Level Output Voltage	Ioh=-1mA	VDD-0.15		V
Vol	Low Level Output Voltage	Ioh=1mA		0.15	V
RDRV	Output driver impedance	VDD=3.3V	*1)	150	Ω

Table 9: electrical characteristic 3.3V IO pin

*1) Some IO pins are able to drive stronger by software configuration. Stronger driving does increase EMC radiation. Please refer software manual to increase or decrease impedance or ask our support.

6 Review service

F&S provide a schematic review service for your baseboard implementation. Please send your schematic as searchable PDF to support@fs-net.de.

7 ESD and EMI implementing on COM

Because there is no connector to „out of case“ there is no ESD protection for any interface. ESD protection has to be placed as near as possible to the ESD source - this is the connector with external access on the COM baseboard. A good guide is available from TI; just search for slva680 at ti.com.

To reduce EMI the PicoCOMA9X supports Spread spectrum. This will normally reduce EMI between 9 and 12 dB and so this decreases your shielding requirements. We strictly recommend having your baseboard with controlled impedance and wires as short as possible.

8 Storage conditions

Maximum storage on room temperature with non condensing humidity: 6 months
Maximum storage on controlled conditions 25 ±5 °C, max. 60% humidity: 12 months
For longer storage we recommend vacuum dry packs.

9 ROHS and REACH statement

All F&S designs are created from lead-free components and are completely ROHS compliant.

The products we supply do not contain any substance on the latest candidate list published by the European Chemicals Agency according to Article 59(1,10) of Regulation (EC) 1907/2006 (REACH) in a concentration above 0.1 mass %.

Consequently, the obligations in No. 1 and 2 paragraphs in Annex are not relevant here. Please understand that F&S is not performing any chemical analysis on its products to testify REACH compliance and is therefore not able to fill out any detailed inquiry forms.

10 Packaging

All F&S ESD-sensitive products are shipped either in trays or bags. PicoCOM modules are shipped in trays. One tray can hold 10 boards. An empty tray is used as top cover.



11 Matrix Code Sticker

All F&S hardware is shipped with a matrix code sticker including the serial number.

Enter your serial number here <https://www.fs-net.de/en/support/serial-number-info-and-rma/> to get information on shipping date and type of board.



12 Appendix

Important Notice

The information in this publication has been carefully checked and is believed to be entirely accurate at the time of publication. F&S Elektronik Systeme assumes no responsibility, however, for possible errors or omissions, or for any consequences resulting from the use of the information contained in this documentation.

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